



ST4-30-1.00-L-D-P-TR ST4-20-2.50-L-D-P-TR
ST4-10-1.00-L-D-P-TR

(0.40 mm) .0158"

ST4 SERIES

ULTRA FINE PITCH HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?ST4

Insulator Material:
Black LCP
Contact Material:
Phosphor Bronze
Plating:
Au or Sn over
50µ" (1.27 µm) Ni
Operating Temp Range:
-55°C to +125°C
Current Rating:
1.6 A per pin
(1 pin powered per row)
RoHS Compliant:

Processing: Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max

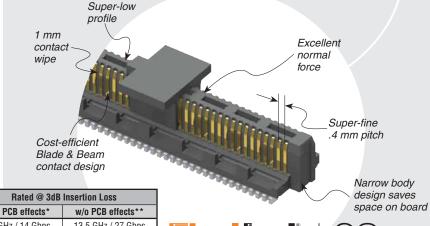
RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



Mates with:

SS4



334/314	Hutou & oub inscriton Loss		
4 mm Stack Height	with PCB effects*	w/o PCB effects**	
Single-Ended Signaling	7.0 GHz / 14 Gbps	13.5 GHz / 27 Gbps	
Differential Pair Signaling	4.5 GHz / 9 Gbps	15.5 GHz / 31 Gbps	

^{*}Performance data includes effects of a non-optimized PCB. **Test board losses de-embedded from performance data.

Performance data for other stack heights and complete test data available at www.samtec.com?ST4 or contact sig@samtec.com

POSITIONS

PER ROW





-1.00 = 1.00 mm -1.50 = 1.50 mm -2.50 = 2.50 mm

LEAD

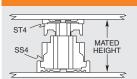
STYLE

— **L** = 10μ" (0.25 μm) Gold on contact, Matte Tin on tail (Required in callout)

-P
= Pick & Place Pad

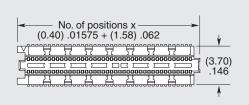
-TR = Tape & Reel

MATED HEIGHT



MATED HEIGHT*				
ST4 LEAD	SS4 LEAD STYLE			
STYLE	-3.00	-3.50		
-1.00	(4.00) .157	(4.50) .177		
-1.50	(4.50) .177	(5.00) .197		
-2.50	(5.50) .217	(6.00) .236		
*Processing conditions will affect mated height.				

Note: Some lengths, styles and options are non-standard, non-returnable.



LEAD STYLE	Α	В
-1.00	(1.00) .039	(3.08) .121
-1.50	(1.50) .059	(3.58) .141
-2.50	(2.50) .098	(4.58) .180

